



Attorney Docket No.: 56937-043

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Satoru TOMEKAWA, et al.

Serial No.: 09/998,327

Filed: December 03, 2001

For: CIRCUIT SUBSTRATE AND MANUFACTURING METHOD THEREOF

Group Art Unit: 2822

Examiner: Monica LEWIS

TECHNOLOGY CENTER 2800

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AMENDMENT UNDER 37 C.F.R. §1.111

Hon. Assistant Commissioner for Patents
Washington, DC 20231

Sir:

In response to the Office Action dated August 28, 2002, having a shortened statutory period for response set to expire November 28, 2002, please amend the above-identified application as follows:

IN THE TITLE:

Please amend the title of the invention to read as follows:

--A CIRCUIT SUBSTRATE HAVING IMPROVED CONNECTION RELIABILITY
AND A METHOD FOR MANUFACTURING THE SAME--.